

## **MOSFET**

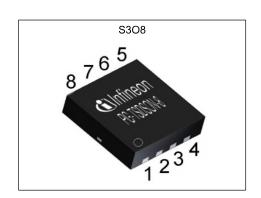
## OptiMOS<sup>™</sup> 3 Power-Transistor, 60 V

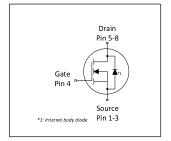
#### **Features**

- Ideal for high frequency switching and sync. rec.
  Optimized technology for DC/DC converters
  Excellent gate charge x R<sub>DS(on)</sub> product (FOM)
  N-channel, normal level
- 100% avalanche tested
- Pb-free plating; RoHS compliant
  Qualified according to JEDEC<sup>1)</sup> for target applications
  Halogen-free according to IEC61249-2-21



Table 1 1toy 1 diretimented 1 di annotation							
Parameter	Value	Unit					
$V_{ m DS}$	60	V					
$R_{DS(on),max}$	11	mΩ					
I <sub>D</sub>	53	A					











Type / Ordering Code	Package	Marking	Related Links
BSZ110N06NS3 G	PG-TSDSON-8	110N06N	-



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# 1 Maximum ratings at $T_A$ =25 °C, unless otherwise specified

Table 2 **Maximum ratings** 

Danamatan		Values				N	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current <sup>1)</sup>	ID	- - -	-	53 33 11	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C, $R_{\rm thJA}$ =60 K/W <sup>2)</sup>	
Pulsed drain current <sup>3)</sup>	I <sub>D,pulse</sub>	-	-	212	Α	T <sub>C</sub> =25 °C	
Avalanche energy, single pulse <sup>4)</sup>	E <sub>AS</sub>	-	-	55	mJ	$I_D$ =20 A, $R_{GS}$ =25 $\Omega$	
Gate source voltage	V <sub>GS</sub>	-20	-	20	V	-	
Power dissipation	$P_{tot}$	-	-	50 2.1	W	T <sub>C</sub> =25 °C T <sub>A</sub> =25 °C, R <sub>thJA</sub> =60 K/W <sup>2)</sup>	
Operating and storage temperature	T <sub>j</sub> , T <sub>stg</sub>	-55	-	150	°C	IEC climatic category; DIN IEC 68-1: 55/150/56	

#### 2 Thermal characteristics

#### Table 3 **Thermal characteristics**

Parameter	Symbol	Values			l lmi4	Note / Test Condition	
Farameter	Symbol	Min. Typ.		Max.	Ullit	Note / Test Condition	
Thermal resistance, junction - case	R <sub>thJC</sub>	-	-	2.5	K/W	-	
Device on PCB, 6 cm² cooling area <sup>2)</sup>	R <sub>thJA</sub>	_	-	60	K/W	-	

<sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature environmental conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed in as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual

See Diagram 3 for more detailed information

<sup>&</sup>lt;sup>4)</sup> See Diagram 13 for more detailed information



# 3 Electrical characteristics at $T_j$ =25 °C, unless otherwise specified

Table 4 **Static characteristics** 

Damamatan	Coursels al	Values			11	Nata / Tank Oam distant	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	60	-	-	V	V <sub>GS</sub> =0 V, I <sub>D</sub> =1 mA	
Gate threshold voltage	$V_{\rm GS(th)}$	2	3	4	V	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =23 μA	
Zero gate voltage drain current	I <sub>DSS</sub>	-	0.1 10	1 100	μA	V <sub>DS</sub> =60 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =25 °C V <sub>DS</sub> =60 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =125 °C	
Gate-source leakage current	I <sub>GSS</sub>	-	10	100	nA	V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V	
Drain-source on-state resistance	R <sub>DS(on)</sub>	-	8.8	11	mΩ	V <sub>GS</sub> =10 V, I <sub>D</sub> =20 A	
Gate resistance	R <sub>G</sub>	-	1.3	-	Ω	-	
Transconductance	$g_{fs}$	16	32	-	S		

Table 5 **Dynamic characteristics** 

Parameter	Constant	Values				No. 4 To a 4 Constitution	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Input capacitance <sup>1)</sup>	Ciss	-	2000	2700	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =30 V, f=1 MHz	
Output capacitance <sup>1)</sup>	Coss	-	440	590	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =30 V, f=1 MHz	
Reverse transfer capacitance	C <sub>rss</sub>	-	17	-	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =30 V, f=1 MHz	
Turn-on delay time	$t_{\sf d(on)}$	-	10	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G}$ =3 $\Omega$	
Rise time	$t_{\rm r}$	-	77	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G}$ =3 $\Omega$	
Turn-off delay time	$t_{ m d(off)}$	-	14	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G}$ =3 $\Omega$	
Fall time	$t_{\mathrm{f}}$	_	6	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G}$ =3 $\Omega$	

Gate charge characteristics<sup>2)</sup> Table 6

Donomotor	Symbol	Values			Unit	Note / Test Condition	
Parameter	Symbol Min. Typ. Max		Max.	Unit	Note / Test Condition		
Gate to source charge	Q <sub>gs</sub>	-	10	-	nC	$V_{DD}$ =30 V, $I_{D}$ =20 A, $V_{GS}$ =0 to 10 V	
Gate charge at threshold	$Q_{g(th)}$	-	6	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 10 V	
Gate to drain charge	$Q_{gd}$	-	2	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 10 V	
Switching charge	Q <sub>sw</sub>	-	7	-	nC	$V_{DD}$ =30 V, $I_{D}$ =20 A, $V_{GS}$ =0 to 10 V	
Gate charge total <sup>1)</sup>	Qg	-	25	33	nC	$V_{DD}$ =30 V, $I_{D}$ =20 A, $V_{GS}$ =0 to 10 V	
Gate plateau voltage	V <sub>plateau</sub>	-	5.2	-	V	$V_{DD}$ =30 V, $I_{D}$ =20 A, $V_{GS}$ =0 to 10 V	
Output charge <sup>1)</sup>	Qoss	-	20	27	-	V <sub>DD</sub> =30 V, V <sub>GS</sub> =0 V	

Defined by design. Not subject to production test See "Gate charge waveforms" for parameter definition

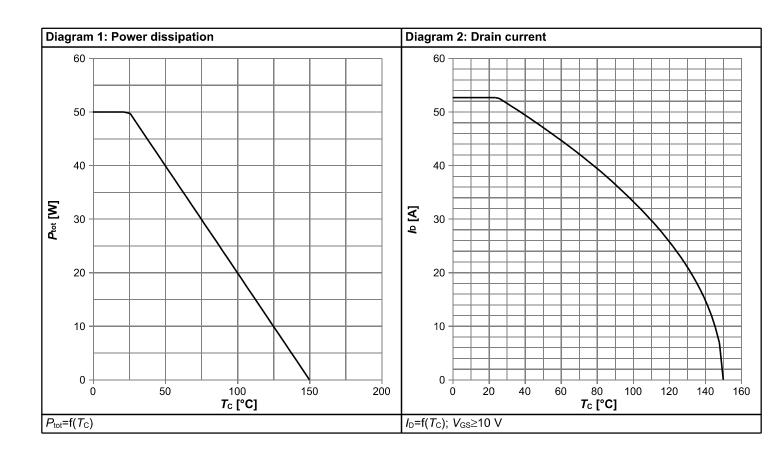


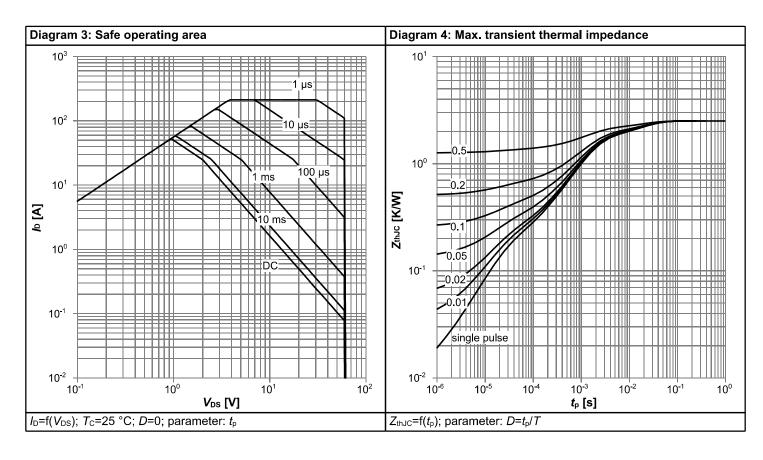
#### Table 7 Reverse diode

Davamatan	Cumph of		Values			No. ( Too ( O o o little )	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode continuous forward current	Is	-	-	38	Α	T <sub>C</sub> =25 °C	
Diode pulse current	I <sub>S,pulse</sub>	-	-	212	Α	T <sub>C</sub> =25 °C	
Diode forward voltage	V <sub>SD</sub>	-	0.9	1.2	V	V <sub>GS</sub> =0 V, I <sub>F</sub> =20 A, T <sub>j</sub> =25 °C	
Reverse recovery time	t <sub>rr</sub>	-	28	-	ns	V <sub>R</sub> =30 V, I <sub>F</sub> =20A, dI <sub>F</sub> /dt=100 A/μs	
Reverse recovery charge	Qrr	-	22	_	nC	$V_R$ =30 V, $I_F$ =2 <i>0A</i> , $di_F/dt$ =100 A/ $\mu$ s	

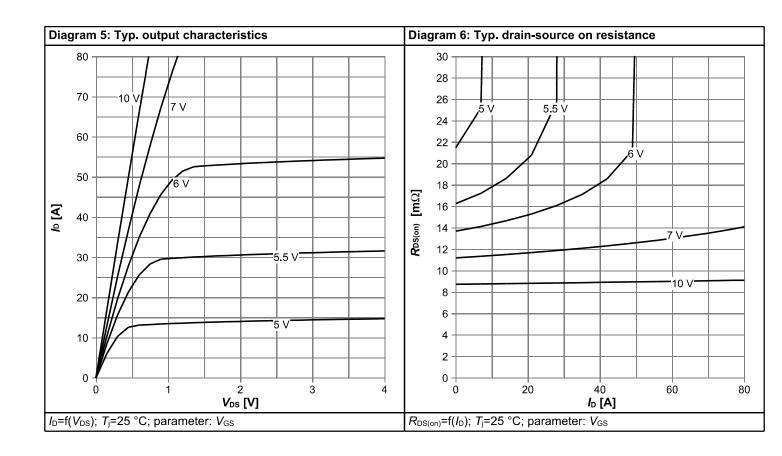


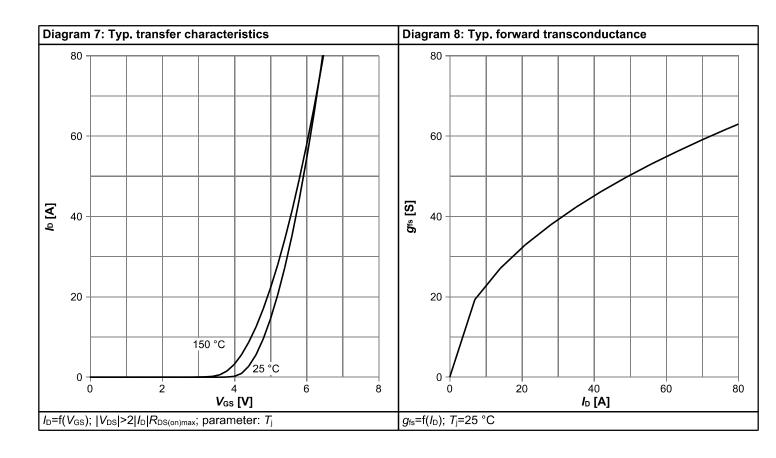
## 4 Electrical characteristics diagrams



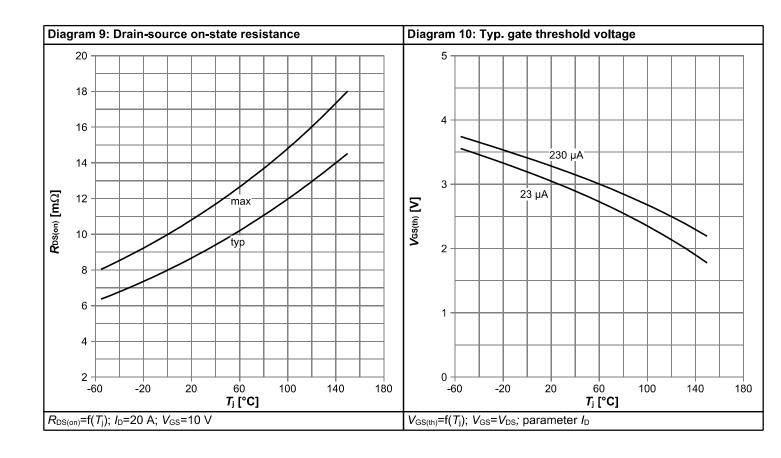


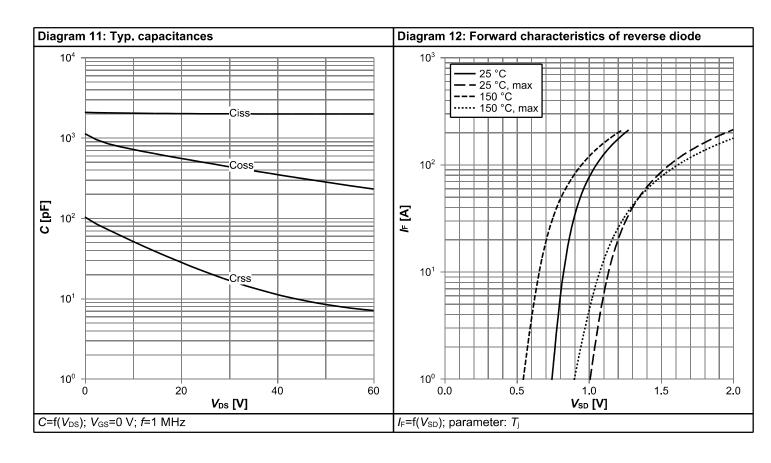




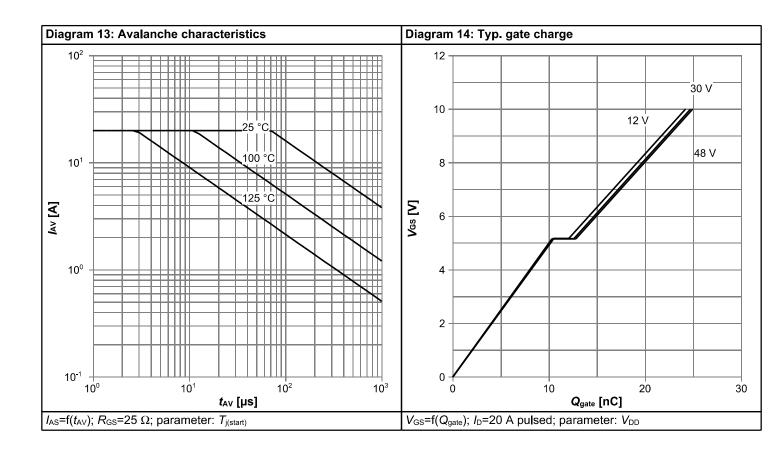


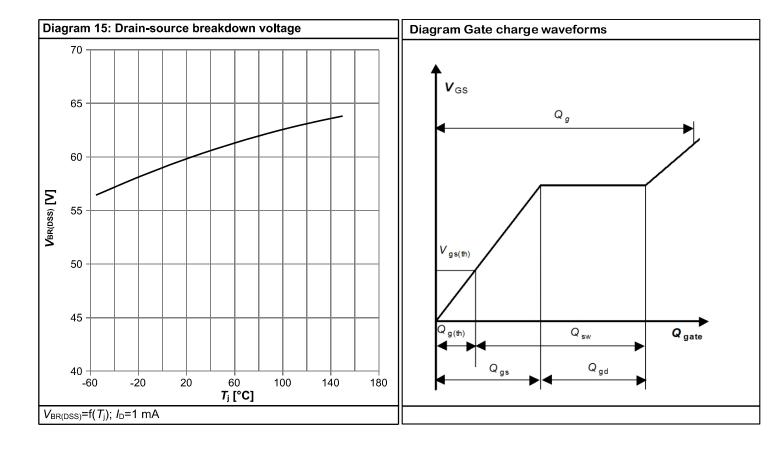






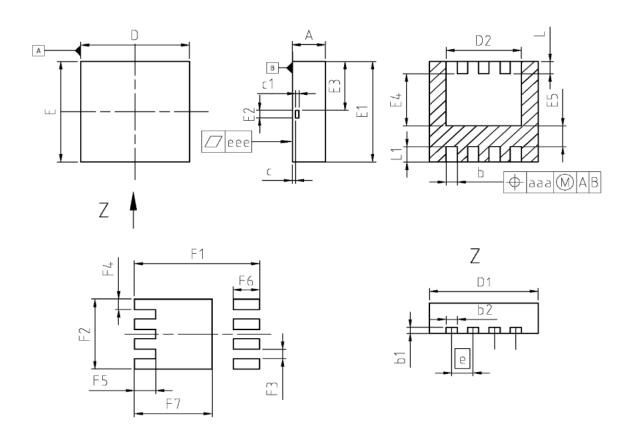








## 5 Package Outlines



DIM	MILLIM	IETER\$	INCHES			
Dille	MIN	MAX	MIN	MAX		
A	0.95	1.00	0.037	0.039		
b	0.25	0.35	0.010	0.014		
b1	0.10	0.30	0.004	0.012		
b2	0.20	0.40	0.008	0.016		
c	0.00	0.20	0.000	0.008		
D=D1	3.20	3.40	0.126	0.134		
D2	2.15	2.35	0.085	0.093		
E=E1	3.20	3.40	0.126	0.134		
E2	0.10	0.30	0.004	0.012		
E3	1.35	1.55	0.053	0.061		
E4	1.60	1.80	0.063	0.071		
E5	0.66	0.86	0.026	0.034		
	0.60	0.70	0.024	0.028		
N		8		8		
L	0.31	0.51	0.012	0.020		
L1	0.33	0.53	0.013	0.021		
aaa	0.2	25	0.010			
666	0.0	05	0.002			
F1	3.70	3.90	0.146	0.154		
F2	2.19	2.39	0.086	0.094		
F3	0.21	0.41	0.008	0.016		
F4	0.24	0.44	0.009	0.017		
F5	0.55	0.75	0.022	0.030		
F6	0.70	0.90	0.028	0.035		
F7	2.26	2.46	0.089	0.097		

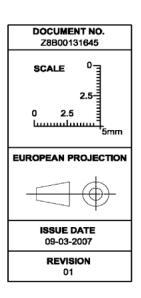


Figure 1 Outline PG-TSDSON-8, dimensions in mm/inches



#### **Revision History**

BSZ110N06NS3 G

Revision: 2021-10-25, Rev. 2.5

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.5	2021-10-25	Update current rating and footnotes

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